

Signatures of long-range-correlated disorder in the magnetotransport of ultrathin topological insulators

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In an ultrathin topological insulator (TI) film, a hybridization gap opens in the TI surface states, and the system is expected to become either a trivial insulator or a quantum spin Hall insulator when the chemical potential is within the hybridization gap. Here we show, however, that these insulating states are destroyed by the presence of a large and long-range-correlated disorder potential, which converts the expected insulator into a metal. We perform transport measurements in ultrathin dual-gated topological insulator films as a function of temperature, gate voltage, and magnetic field, and we observe a metalliclike nonquantized conductivity, which exhibits a weak antilocalizationlike cusp at low magnetic fields and gives way to a nonsaturating linear magnetoresistance at large fields. We explain these results by considering the disordered network of electron- and hole-type puddles induced by charged impurities. We argue theoretically that such disorder can produce an insulator-to-metal transition as a function of increasing disorder strength, and we derive a condition on the band gap and the impurity concentration necessary to observe the insulating state. We also explain the linear magnetoresistance in terms of strong spatial fluctuations of the local conductivity using both numerical simulations and a theoretical scaling argument.

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I. INTRODUCTION

Three-dimensional (3D) topological insulators (TIs) are an exotic state of matter in which gapless electronic excitations exist at the surface of a bulk system with gapped conduction and valence bands [1]. These surface states exhibit a number of interesting phenomena associated with their linear dispersion and spin-momentum locking [2], including magnetic monopole responses to an applied electric field [3] and a strong magnetoelectric effect [4]. Angle-resolved photoemission spectroscopy (ARPES) measurements have identified gapless Dirac surface states in several materials, including $\text{Bi}_{1-x}\text{Sb}_x$, Bi_2Se_3 , Sb_2Te_3 , and Bi_2Te_3 [2].

When a TI crystal is made very thin, however, the nature of the surface states undergoes a significant change. In such ultrathin TI films, electrons have a finite amplitude for quantum tunneling between the top and bottom surfaces, resulting in a hybridization gap for the surface states whose magnitude depends on the film thickness d [5,6]. For appropriate values of the film thickness and for a sufficiently clean system, this gap can stabilize the quantum spin Hall state, which is characterized by one-dimensional helical edge states around

the border of the TI surface {as has been observed in magnetically doped TI films [7] and in the two-dimensional (2D) TI HgTe/CdTe [8,9]}.

One can therefore expect a basic dichotomy of possibilities for an undoped ultrathin TI film. Either the system becomes a trivial insulator with a vanishing conductivity in the limit of zero temperature, or it becomes a quantum spin Hall insulator with a quantized conductance. The fate of the TI film, *vis-à-vis* these two possibilities, is predicted to depend in a nontrivial way on the value of the thickness d with the system oscillating between a quantum spin Hall and a trivial insulating state as a function of thickness [6].

In this paper, however, we find evidence for a third possibility outside of this dichotomy in which a hybridization gap exists, but the insulating state is destroyed by the presence of long-range-correlated disorder. We measure the resistivity of ultrathin films of pristine $(\text{Bi}_x\text{Sb}_{1-x})_2\text{Te}_3$ with $x = 0.2$ as a function of temperature, chemical potential, and magnetic field, and we find a number of features that suggest that a dominant role is played by long-range-correlated disorder, which arises inevitably due to charged impurities in the film and in the substrate. Our films are four quintuple layers (QLs) thick, which is predicted to produce a quantum spin Hall insulator [6], but we find instead a finite nonquantized value

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of the resistance in the limit of zero temperature. We provide an explanation for this observation in terms of an insulator-to-metal transition produced by increasing long-ranged disorder. We also observe a prominent weak antilocalization correction and a large linear magnetoresistance at high magnetic fields, which we explain in terms of strong spatial fluctuations of the local conductivity.

The remainder of this paper is organized as follows. In Sec. II, we briefly describe our sample preparation and measurement setup. Section III describes our zero-field measurements and presents theoretical arguments to explain a resistivity that is both finite and nonquantized in the limit of zero temperature. Section IV presents results for the resistivity as a function of magnetic field and gate voltage along with a theoretical discussion of both the weak antilocalization corrections and the linear magnetoresistance that we observe.

II. SAMPLE PREPARATION AND MEASUREMENT SETUP

Our TI films are made from four QLs of $(\text{Bi}_{0.2}\text{Sb}_{0.8})_2\text{Te}_3$ grown on a $\text{SrTiO}_3(111)$ substrate using molecular-beam epitaxy in an ultrahigh vacuum. Each QL layer is ~ 1 -nm thick. The Bi, Sb, and Te effusion cells as well as the $\text{SrTiO}_3(111)$ substrate are held at high temperatures in order to ensure precise control of surface stoichiometry. The crystallinity of the films is monitored by reflection high-energy electron diffraction pattern. More detailed characterization of these films is presented in Refs. [10,11].

To prevent oxidation in ambient conditions, 2 nm of amorphous tellurium and 2 nm of alumina capping layer is deposited on top of the films. The samples tend to degrade at high temperatures, and hence all the processing was performed at no higher than 100°C . Contacts were made using electron-beam lithography. In the dual-gated devices, the top-gate dielectric was made from 20 nm of HfO_2 grown by atomic layer deposition [12]. Magnetotransport measurements are performed in a dilution refrigerator with an 8-T magnet and using standard low-frequency lock-in techniques. Results in this paper are taken from five Hall bar devices, which we denote as H_1 , H_2 , H_3 , H_4 , and H_5 .

III. TRANSPORT AT ZERO MAGNETIC FIELD

As mentioned in the Introduction, hybridization between the two parallel TI surfaces leads to a gap opening at the Dirac point of the surface dispersion relation (as illustrated in Fig. 1). The size Δ of this gap is generally expected to be between 5 and 50 meV; this range encompasses estimates from density functional theory and tight-binding models for the gaps in four-QL-thick Bi_2Se_3 and Bi_2Te_3 [6]. For situations where the chemical potential resides in the middle of the gap and there is no band bending, one would expect the TI surface to become an insulator with an activation energy $\Delta/2$ for the conductivity. Such a state would have either zero conductivity in the limit of zero temperature (if the system is a trivial insulator) or a quantized conductance $2e^2/h$ (if the system forms a quantum spin Hall state).

Using a dual-gated field-effect transistor setup, we shift the chemical potential for both the top and the bottom surfaces of our samples across a wide range in order to search for

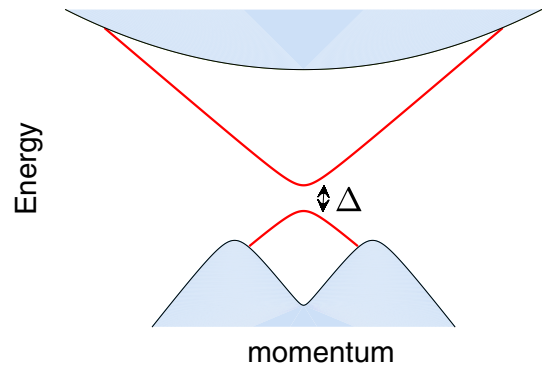


FIG. 1. Schematic of the dispersion of the Dirac surface states (red lines). Hybridization between top and bottom surfaces opens a small gap Δ at the Γ point. The bulk conduction- and valence-band states are denoted by the upper and lower blue shaded areas, respectively.

these insulating states. At high negative voltages, the chemical potential resides far below the energy of the Dirac point, whereas at large positive voltages the chemical potential is high above. When the two gate voltages are chosen such that both surfaces are at the charge-neutral point (CNP), the system assumes its maximally insulating state. This behavior is shown in Fig. 2 for five different samples as a function of the back-gate voltage. (The behavior as a function of both back- and top-gate voltages is discussed in Appendix B)

Contrary to the expectation for a clean system, our measurements reveal a conductivity that is neither insulatinglike nor quantized. Indeed, Fig. 2 shows that the resistance takes a value of order h/e^2 at the CNP, but this value varies from one sample to the next. As shown in Fig. 3, the resistivity depends very weakly on temperature, even though the temperature is far below $\Delta/k_B \gtrsim 50$ K. Using the traditional description of

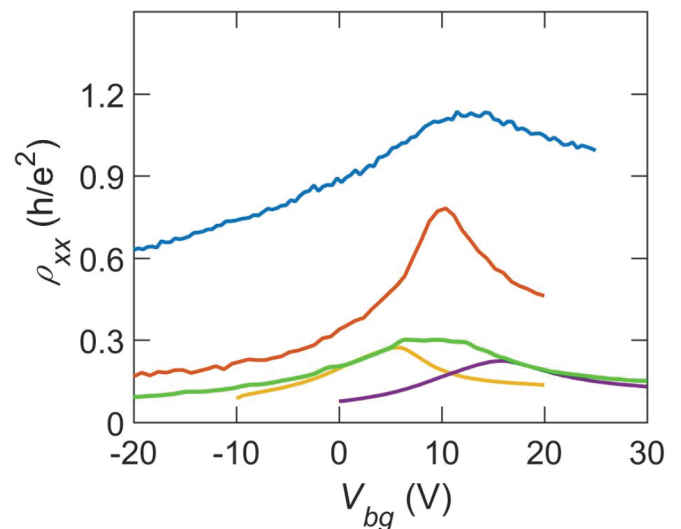


FIG. 2. Sheet resistivity of five different Hall bar devices—denoted H_1 (blue curve), H_2 (brown), H_3 (green), H_4 (yellow) and H_5 (purple)—as a function of back-gate voltage. The top-gate voltage is held fixed at $V_{tg} = 0$. The measurement temperature was ~ 30 mK.

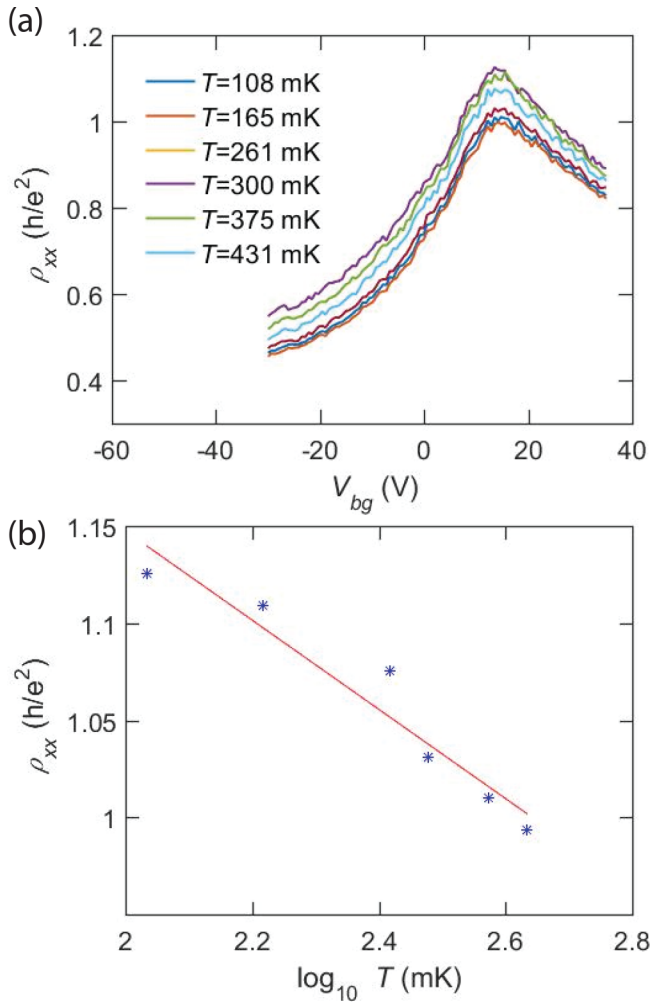


FIG. 3. (a) The longitudinal resistivity ρ_{xx} of device H₁ as a function of back-gate voltage for different values of the temperature. (b) The maximal resistivity (corresponding to the CNP) of device H₁ is plotted as a function of temperature, showing only a weak, logarithmic dependence on temperature.

an undoped semiconductor, one would predict an activated dependence $\rho_{xx} \propto \exp[\Delta/(2k_B T)]$.

Taken together, these two observations suggest that the system is not well described by either the clean band insulator or quantum spin Hall insulator states. The most trivial explanation for our results would be that the surface bands simply do not have a band gap. For example, in four-QL-thick films of Bi₂Te₃ the Dirac point lies within a deep local minimum of the valence band [13], and consequently there is no finite window of energy with zero density of states. In Sb₂Te₃, tunneling experiments have shown that films of the same thickness have a thermodynamic gap that is no larger than a few meV [14]. Still, it is worth considering whether there is another more interesting explanation for the lack of insulating behavior, especially since similar results have been recorded for transport in thin films of Bi₂Se₃ [15], despite a Dirac point that lies well outside the bulk valence-band states and a gap Δ on the order of tens of meV [6,16]. For bulk samples of (Bi_{1-x}Te_x)₂Te₃, the location of the Dirac point shifts within the bulk gap as a function of the composition

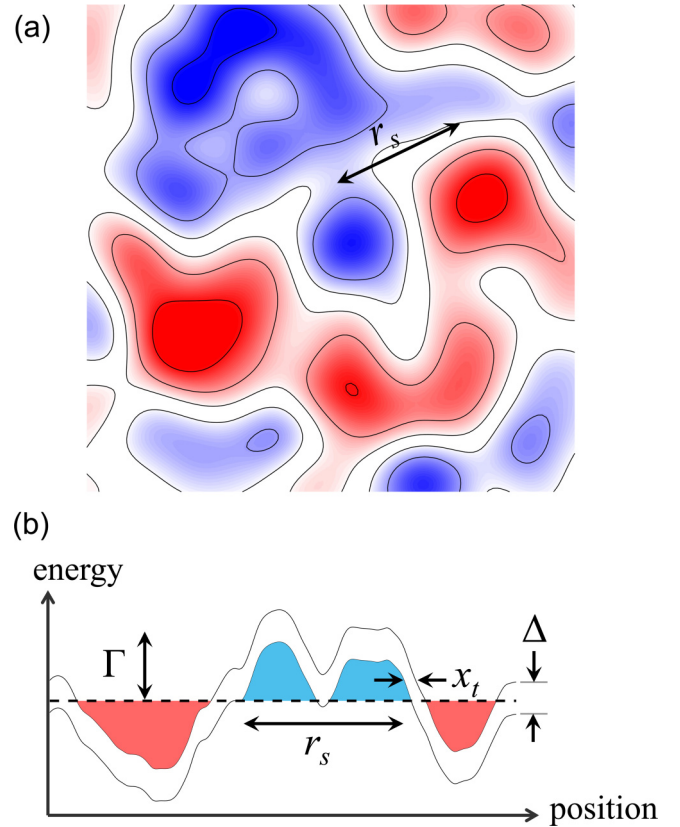


FIG. 4. (a) Schematic of the disorder potential landscape. Charged impurities produce a slowly varying Coulomb potential that locally creates puddles of electrons (red) and holes (blue). The typical correlation length of the potential, r_s is labeled, and thin black lines show contours of constant potential. White regions denote tunnel barriers between electron and hole puddles, which exist at large enough band-gap Δ . (b) A schematic of band bending, showing the energy along some particular direction on the surface. The surface band-gap Δ is labeled along with the typical magnitude Γ of the disorder potential and the width x_t of the tunnel barrier between electron and hole puddles.

x so that at not-too-small values of x its position is similar to what is shown in Fig. 1 (see, e.g., Ref. [17] for a discussion).

The apparent breakdown of the clean insulator picture can be rationalized by considering the effects of long-ranged disorder induced by Coulomb impurities, which exist both in the TI film and in the substrate. Such impurities are known to provide long-wavelength fluctuations of the local Fermi energy, which provide a finite density of states at zero energy due to band bending [18]. (A similar picture of fluctuating Fermi energy in the presence of an insulating gap has been used to describe, for example, graphene nanoribbons [19] and dual-gated bilayer graphene [20].) This random band-bending effect is illustrated in Fig. 4. When the surface gap Δ is sufficiently large, the fluctuations of the Fermi energy lead to the formation of isolated electron and hole puddles [red and blue regions of Fig. 4(a), respectively], separated by insulating tunnel barriers (white regions). When the chemical potential μ is precisely in the middle of the band gap (which we define as $\mu = 0$), electron and hole puddles appear in equal numbers. One can estimate the condition for maintaining a

good insulating state at $\mu = 0$ by demanding that the typical tunneling action S for electron tunneling across such a barrier satisfy $S \gg \hbar$.

To estimate the action S , we first assume that the typical magnitude Γ of the disorder potential is sufficiently large that $\Gamma \gg \Delta$. We also assume that the typical correlation length r_s of the potential is much larger than the film thickness. Both of these assumptions are validated below. Under these assumptions one can use numerical estimates for Γ and r_s based on a gapless TI surface [21,22]. These estimates give

$$\Gamma \simeq \left(\frac{\pi^3 \alpha_s^2}{2} \right)^{1/6} \hbar v N_i^{1/3}, \quad (1)$$

and

$$r_s \simeq \frac{N_i^{-1/3}}{(2\alpha_s)^{4/3}}, \quad (2)$$

where N_i is the (three-dimensional) concentration of impurities in the TI film and substrate, \hbar is the reduced Planck constant, v is the Dirac velocity, and $\alpha_s = e^2/(4\pi\epsilon_0\epsilon\hbar v)$ is the effective fine-structure constant with ϵ as the effective dielectric constant and ϵ_0 as the vacuum permittivity. If one assumes an impurity concentration of order 10^{19} cm^{-3} (as is typical for antisite defects and vacancies in TI crystals [23]), a Dirac velocity v of order $5 \times 10^5 \text{ m/s}$, and an effective dielectric constant ϵ as large as several hundred (due to the close proximity of the highly polarizable SrTiO₃ substrate), then α_s is of order 0.1, the disorder potential Γ is of order 20 meV, and $r_s \sim 40 \text{ nm}$. It is worth noting that at chemical potentials far from the CNP, both r_s and Γ will generally be smaller than their $\mu = 0$ values. At small Δ , the dependence of the disorder potential amplitude Γ on the gap Δ is weak, so that one can use the result of Eq. (1), which corresponds to $\Delta = 0$. The dependence of Γ on the gap Δ is discussed in more detail in Ref. [18].

In order to estimate the width x_t of the typical spatial separation between electron and hole puddles, one can note that the typical in-plane electric field is $F \sim \Gamma/(er_s)$ so that x_t is given by $eFx_t \sim \Delta$. Solving for x_t and substituting Eqs. (1) and (2) gives $x_t \sim 4\pi\epsilon_0\epsilon\Delta/(\alpha_s^{2/3}e^2N_i^{2/3})$. The typical tunneling action between electron and hole puddles can be estimated as the product of the height $\sim\Delta$ of the tunnel barrier and the time $\sim x_t/v$ needed to traverse it. So $S \sim \Delta x_t/v \sim \hbar\Delta^2/[\alpha_s^{5/3}(\hbar v N_i^{1/3})^2]$. For the system to be insulating, one must have $S \gg \hbar$, which is equivalent to

$$\Delta \gg \alpha_s^{5/6} \hbar v N_i^{1/3}. \quad (3)$$

Equation (3) can be viewed as a generic requirement for the existence of an insulating state in a gapped 2D system on a substrate with charged impurities. That is, either the gap Δ must be large enough or the impurity concentration N_i must be small enough that Eq. (3) is satisfied.

In our samples, the right-hand side of Eq. (3) is of order 10 meV. For much smaller values of the gap, one can say that electron and hole puddles are well connected by quantum tunneling, and there is no meaningful ‘‘insulating barrier’’ between them. Our samples apparently correspond to such a situation where Eq. (3) is violated so that one can think of the surface as effectively ungapped even though Δ is finite.

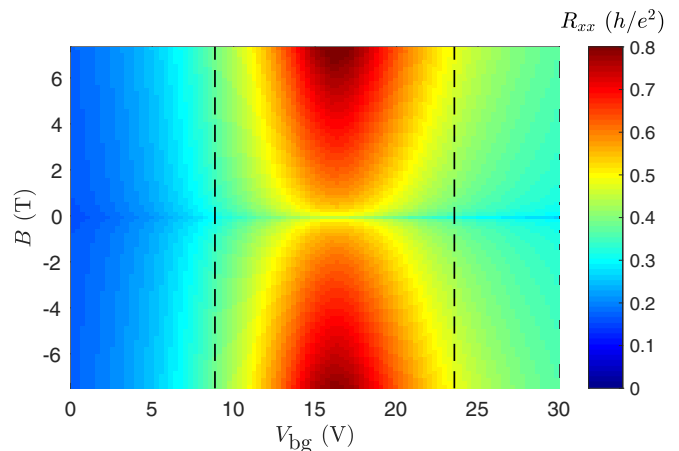


FIG. 5. Longitudinal resistance R_{xx} of device H₅ as a function of back-gate voltage V_{bg} and magnetic-field B . The measurement temperature $T = 50 \text{ mK}$. R_{xy} is everywhere much smaller than R_{xx} . The vertical dashed lines demarcate the three regimes of voltage depicted in Figs. 6(a)–6(c).

Producing a well-insulating TI thin film apparently requires either a larger hybridization gap Δ or a much smaller impurity concentration N_i . For the remainder of this paper we set $\Delta = 0$ when discussing transport.

The zero-field dc resistivity is given by $\rho = (h/e^2)/(k_F\ell)$, where k_F is the typical Fermi wave vector and ℓ is the electron mean free path. For the puddled scenario depicted in Fig. 4, the typical value of k_F at zero chemical potential is $\sim\alpha_s^{1/3}N_i^{1/3}$, whereas the mean free path is on the same order as r_s . Thus, the resistivity at zero chemical potential is given by [21]

$$\rho_{\max} \simeq \frac{\hbar}{e^2} \alpha_s \ln(1/\alpha_s). \quad (4)$$

For our samples, this expression gives a value of order $\approx 0.3h/e^2$.

Our picture of conduction through a spatially disordered landscape is also consistent with measurements of the superconducting proximity effect, which we present in Appendix C.

IV. MAGNETOTRANSPORT

We also study the electron transport under the application of a perpendicular magnetic field. The measured longitudinal resistance R_{xx} is plotted in Fig. 5 for device H₅ as a function of the field strength B and the back-gate voltage V_{bg} . For a given magnetic field, the resistance is maximized near the CNP, which for this device corresponds to $V_{bg} \approx 16 \text{ V}$. The resistance also increases monotonically as a function of B . In general, we observe an asymmetry between positive and negative voltages relative to the CNP with negative voltages generally corresponding to smaller resistance. This asymmetry suggests that negative values of the chemical potential correspond to a larger density of states than positive values of the chemical potential, which may arise either because of curvature of the Dirac band or because of proximity of the Dirac point to the bulk valence-band states (as depicted in Fig. 1). In our measurement conditions, the Hall resistance R_{xy} is everywhere

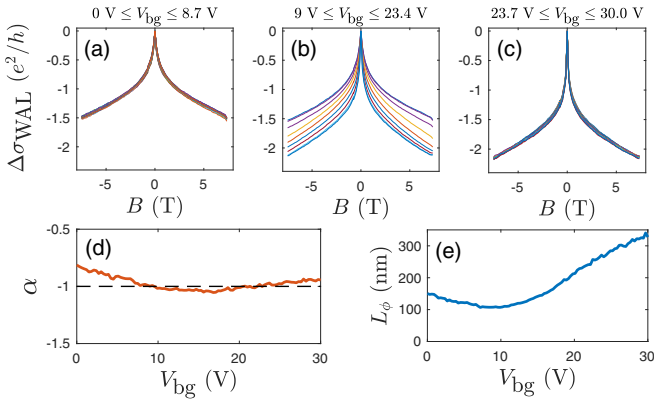


FIG. 6. (a)–(c) The measured WAL correction to the conductivity of device H_5 as a function of magnetic field for different ranges of the back-gate voltage V_{bg} (the range of V_{bg} is indicated in the title of each plot and is equivalent to the three ranges demarcated in Fig. 5). For each plot, the different curves correspond to different values of V_{bg} . (d) The value of the constant α extracted from a fit to Eq. (5) as a function of V_{bg} . (e) The extracted phase coherence length as a function of V_{bg} . The measurement temperature is $T = 50$ mK.

much smaller than the longitudinal resistance R_{xx} ; this is shown explicitly in Appendix A. Thus we can approximate the conductivity $\sigma \simeq (L/w)/R_{xx}$, where $L/w \approx 2$ is the aspect ratio of the sample H_5 . The leading-order correction to this expression is of order $(R_{xy}/R_{xx})^2$, which is smaller than 5% throughout the regime of our measurements.

Our data show two notable features as a function of the magnetic field. For any given gate voltage there is a sharp cusp in $R_{xx}(B)$ near $B = 0$, which previous experimental studies have attributed to weak antilocalization (WAL) [15,24–27]. The correction $\Delta\sigma_{\text{WAL}}$ to the conductivity associated with WAL is described by the theory of Hikami *et al.* [28],

$$\Delta\sigma_{\text{WAL}} = \frac{\alpha e^2}{\pi h} \left[\psi \left(\frac{1}{2} + \frac{\hbar}{4eBL_\phi^2} \right) - \ln \left(\frac{\hbar}{4eBL_\phi^2} \right) \right]. \quad (5)$$

Here $\psi(z)$ is the Digamma function, L_ϕ is the phase coherence length, and α is a numerical coefficient defined so that $\alpha < 0$ indicates WAL and $\alpha > 0$ corresponds to weak localization. The quantity $2|\alpha|$ is usually associated with the number of parallel conduction channels.

In Fig. 6, we plot $\Delta\sigma_{\text{WAL}} = \sigma(B) - \sigma(0)$ as a function of magnetic field for different values of the back-gate voltage. The sharp logarithmic cusp of $\Delta\sigma_{\text{WAL}}(B)$ is consistent with Eq. (5), and we can perform good fits in the range of $-2 \text{ T} < B < 2 \text{ T}$ in order to extract the parameters α and L_ϕ . Interestingly, for low enough voltages that the chemical potential is far below the CNP, we find that all measured curves $\Delta\sigma_{\text{WAL}}(B)$ are identical, irrespective of the gate voltage [Fig. 6(a)]. Similarly, all measured values of $\Delta\sigma_{\text{WAL}}(B)$ for voltages far above the CNP also collapse onto a single curve [Fig. 6(c)], although this curve is distinct from the one corresponding to low voltages. In the intermediate voltage range of $9 \text{ V} \leq V_{bg} \leq 23.4 \text{ V}$ (between the two dashed vertical lines in Fig. 6), the behavior of $\Delta\sigma_{\text{WAL}}(B)$ transitions smoothly from one limiting curve to the other [Fig. 6(b)]. We interpret these two limiting curves as corresponding to

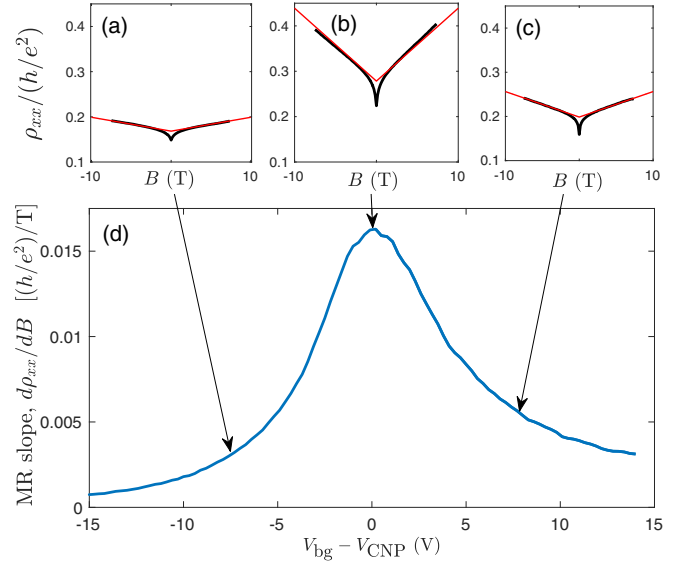


FIG. 7. (a)–(c) The resistance R_{xx} of Hall bar device H_5 as a function of magnetic field is shown for different values of the back-gate voltage, whose value for each plot is indicated by the arrow pointing downward. The thick black line in each plot shows the experimental data, and the thin red line is a straight-line guide to the eye that indicates the linear slope of R_{xx} versus $|B|$. (d) The value of the slope dR_{xx}/dB of device H_5 at large B is plotted as a function of back-gate voltage V_{bg} . $V_{\text{CNP}} \approx 16 \text{ V}$ indicates the voltage at the charge neutral point.

chemical potentials either far below or far above the Dirac point. In the latter case, the current is carried only by the linear Dirac surface states above the gap. In the opposite limit of small V_{bg} , the current moves through an admixture of Dirac surface states and valence-band states. For intermediate voltages, the disorder potential mixes these two behaviors spatially by random band bending.

By fitting our data to Eq. (5), we are able to extract estimates for the constant α and the phase-coherence length L_ϕ as a function of the back-gate voltage. These results are shown in Figs. 6(d) and 6(e), respectively. It is worth remarking that the inferred value of α is everywhere close to -1 as one might expect for a conduction process with two parallel channels (arising from the two parallel surfaces). The estimated phase-coherence length is on the order of several hundred nanometers, consistent with previous studies at low temperatures [24,26]. Our interpretation of WAL is also consistent with the logarithmic temperature dependence of the resistivity observed at zero field and low temperatures [shown in Fig. 3(b)], since increased temperature leads to a shorter phase-coherence length L_ϕ , which enters the conductivity in the argument of a logarithm.

At larger magnetic fields, the WAL correction gives way to a resistance that increases linearly with magnetic-field strength with no evidence of saturation. As shown in Fig. 7, this linear magnetoresistance (LMR) effect is most prominent near the CNP. As the chemical potential is moved away from the CNP in either direction, the slope of the LMR is reduced.

Multiple explanations have been proposed during the past few decades for nonsaturating LMR in 2D electron systems.

For example, Wang and Lei have proposed a mechanism for LMR on a TI surface based on Zeeman splitting [29]. However, the magnitude of the LMR associated with this mechanism is much smaller than the value we observe. Indeed, to explain our largest observed LMR slope with the Zeeman splitting mechanism would apparently require an electron g factor of several hundred, which seems inconsistent with transport experiments in a tilted magnetic field [30]. Other authors have explored more generic semiclassical explanations for LMR and have shown how it can arise from either persistent gradients of electron density [31] or mesoscopic spatial fluctuations of the mobility [32,33]. Such fluctuations are commonly treated using either resistor network models [32] or effective medium approaches [34,35], which give largely equivalent results [36].

Similar to these latter approaches, we suggest a way to understand our results based on a simple model in which the system is described by a local Drude-like conductivity tensor that varies as a function of position due to spatial fluctuations in the electron density. In particular, we suppose that one can define local longitudinal and Hall conductivities $\sigma_{xx}(\mathbf{r})$ and $\sigma_{xy}(\mathbf{r})$, respectively, which vary as a function of position \mathbf{r} . Such a description is generally valid so long as variations in the electron density occur over a length scale r_s that is much longer than the mean free path ℓ or the Fermi wavelength $\sim k_F^{-1}$.

In the Drude model, the ratio $\sigma_{xy}/\sigma_{xx} = \omega_c \tau$, where ω_c is the cyclotron frequency and τ is the transport scattering time. For a gapless Dirac system,

$$\omega_c \tau = \frac{eB\ell}{\hbar k_F}, \quad (6)$$

where k_F is the local value of the Fermi momentum and $\ell = v\tau$ is the local mean free path. (As declared above, we are again ignoring the effects of any small band-gap Δ .) Note that the ratio σ_{xy}/σ_{xx} becomes large when B is sufficiently large. The value of the local Fermi momentum can be described by the Thomas-Fermi equation,

$$E_F[k_F(\mathbf{r})] - e\phi(\mathbf{r}) = \mu, \quad (7)$$

where $E_F = \hbar v k_F \times \text{sgn}(\mu + e\phi)$ is the Fermi energy relative to the Dirac point and $\phi(\mathbf{r})$ is the electrostatic potential. The variation of k_F with position implies that the value of $\omega_c \tau$ also varies as a function of position and should not, in general, be considered as a global constant. We also note that, although our description of the system involves both electron-type and hole-type puddles, a given region of space is presumed to contain only one or the other carrier type. In this sense the model that we consider is distinct from “two-carrier models” (see, e.g., Ref. [37]) in which both electron- and hole-type carriers are assumed to coexist at all regions of space due to overlapping bands.

In order to understand the appearance of LMR within this model, consider first the case when the system is close enough to the CNP that electron and hole puddles exist in almost equal number $|\mu| \ll \Gamma$. This is the regime where the LMR is observed to be most prominent experimentally, and one can understand its appearance using the following scaling arguments. Near the CNP, electron and hole puddles are nearly equally abundant, and the local conductivity at the boundary

between puddles is small because of the locally vanishing value of the electron density. Consequently, the current across the system is forced to pass through narrow “pinch points” of the random potential where the electric potential is close to zero and adjacent electron- or hole-type puddles are narrowly separated. These pinch points provide the bottleneck for conduction, and they become more prominent with increasing magnetic field [38]. (See Appendix D for simulated images of current flow.) One can think that an order unity number of such pinch points exist per square area $\sim r_s^2$ and, consequently, if G is the typical conductance of the pinch point, then the longitudinal resistivity of the system is $\rho_{xx} \sim 1/G$.

To estimate the typical conductance G of the pinch point, one can exploit the result for the (two-terminal) conductance of a square with nonzero Hall conductivity [39–41]: $G_{\square} = \sqrt{\sigma_{xx}^2 + \sigma_{xy}^2}$. If the magnetic-field B is large enough, then $|\sigma_{xy}| \gg \sigma_{xx}$ at the pinch point, and we arrive at the relation $\rho_{xx} \sim 1/|\sigma_{xy}^{(0)}|$, where $\sigma_{xy}^{(0)}$ represents the Hall conductivity at the pinch point. At $\omega_c \tau \gg 1$, the Hall conductivity $\sigma_{xy} \simeq en/B = \pm ek_F^2/(2\pi B)$, and so our result for the longitudinal resistivity is equivalent to

$$\rho_{xx} \sim \frac{h}{e^2} \frac{eB}{\hbar [k_F^{(0)}]^2}, \quad (8)$$

where $k_F^{(0)}$ represents the typical Fermi momentum at the pinch point.

In general, pinch points are locations where the random potential is close to zero. Thus, if the chemical potential is not too close to zero, then Eq. (7) implies $k_F^{(0)} = |\mu|/(\hbar v)$. As the chemical potential is shifted away from the CNP, the corresponding value of $k_F^{(0)}$ increases, and the slope of the magnetoresistance declines. This is consistent with the experimental result in Fig. 7. On the other hand, as one approaches the CNP very closely, both the typical spatial size of the pinch point and its typical Fermi momentum are reduced, and the resistance increases. Although the relation $k_F^{(0)} = |\mu|/(\hbar v)$ implies a divergence of the resistance at $\mu \rightarrow 0$, such a divergence may be truncated by the finite mean free path. In other words, since the local conductivity is not well defined at scales shorter than the mean free path ℓ , one can think that the minimal size of the pinch point is $\sim \ell$ and, consequently, that the minimal value of $k_F^{(0)}$ is $\sim \overline{k_F} \ell / r_s$, where $\overline{k_F}$ is the typical value of k_F near the center of an electron or hole puddle. Using the estimates for $\overline{k_F}$ and ℓ presented below and inserting the expression for $k_F^{(0)}$ into Eq. (8), gives a maximum magnetoresistance slope of order $\rho_{xx} \sim 0.03(h/e^2)$ per Tesla of field. This is consistent in order of magnitude with our measured result.

In order to test our scaling arguments quantitatively, we implemented numeric finite-element simulations of current flow through a Hall bar geometry with a correlated disorder potential and a Drude-like conductivity tensor having a local value of $k_F(\mathbf{r})$ given by Eq. (7). For simplicity, our simulations assume a transport scattering time τ that is independent of energy or position. Although there is no reason *a priori* to expect this assumption to be accurate quantitatively, the scaling argument leading to Eq. (8) suggests that the longitudinal resistivity ρ_{xx} becomes independent of τ at sufficiently

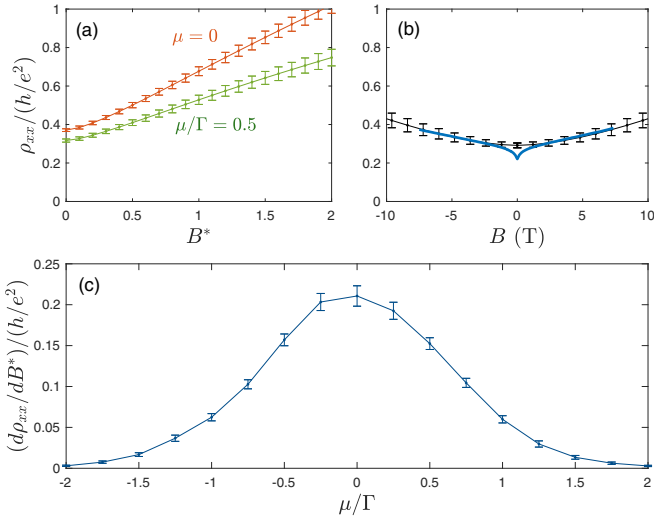


FIG. 8. Magnetoresistance for a simulated Hall bar with random disorder. (a) Two example curves are plotted for ρ_{xx} as a function of the dimensionless magnetic-field $B^* = B\ell^2/(\hbar e)$. Both curves correspond to $\overline{k_F}\ell = 6$, where $\overline{k_F}$ is the root-mean-square deviation of the Fermi momentum from its mean value and ℓ is the mean free path, which is taken to be a constant. The curves are labeled by their corresponding value of the chemical potential μ , normalized to the root-mean-square amplitude Γ of the disorder potential. (b) shows a fit to the experimental data (thick blue curve, corresponding to device H₅) for $\rho_{xx}(B)$ at the charge-neutral point ($\mu = 0$). The simulation data (black line with error bars) correspond to $\overline{k_F} = 0.88 \text{ nm}^{-1}$ and $\overline{k_F}\ell = 6.5$. (c) The magnetoresistance slope $d\rho_{xx}/dB^*$ is plotted as a function of chemical potential μ , normalized to the disorder potential amplitude Γ . The slope is calculated by a linear fit to simulation data in the interval $0.2 < B^* < 1$, and, in this example, $\overline{k_F}\ell = 6$ is held constant.

large fields. As shown in Fig. 8, the simulation consistently reproduces the LMR trend as well as the decline in the LMR slope with increasing chemical potential. Details of the simulation method are provided in Appendix D (along with results for ρ_{xy} , which are consistent with experiment). Within the assumption of a constant scattering time, one can fit the experimental data at the CNP quantitatively by setting the root-mean-square Fermi momentum $\overline{k_F} = 0.88 \text{ nm}^{-1}$ and the mean free path $\ell = 7.4 \text{ nm}$. More details about the fitting are provided in Appendix D.

V. CONCLUSION

In this paper, we have presented experimental results for the resistivity of thin TI films as a function of temperature, chemical potential, and magnetic field. In the absence of disorder, these systems are predicted to form a quantum spin Hall state. We find, however, that the transport in our system is dominated by long-range fluctuations of the disorder potential, presumably induced by charged impurities in the film and in the substrate. In particular, such long-ranged disorder creates a random landscape of p - and n -type regions, and this landscape destroys the insulating state. Our theoretical

arguments suggest that one may reach an insulating state only when the gap is large enough and the impurity concentration is low enough that Eq. (3) is satisfied.

The magnetotransport shows signs of both weak antilocalization and a nonsaturating linear magnetoresistance. The WAL correction $\Delta\sigma_{\text{WAL}}(B)$ is described well by the usual Hikami-Larkin-Nagaoka theory, Eq. (5), with two parallel conduction channels ($\alpha \approx -1$). We also find that $\Delta\sigma_{\text{WAL}}(B)$ collapses onto one of two curves when the chemical potential is far from the CNP. We have shown that the linear magnetoresistance can be interpreted as the result of spatial fluctuations in the local conductivity arising from strong disorder fluctuations. Our estimate of the linear MR slope and its dependence on chemical potential are both consistent with observations.

Taken together, our results provide new understanding of electron transport in ultrathin topological insulators and may bring us closer to realizing ideal quantum spin Hall insulators. More broadly, our improved understanding of the disorder-induced insulator-to-metal transition and LMR may be important for a wide class of disordered 2D electron systems.

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APPENDIX A: HALL MEASUREMENTS

In the main text, we focused on the longitudinal resistance R_{xx} and ignored the transverse Hall resistance R_{xy} . Here, we present results for R_{xy} , and we show that it is everywhere much smaller than R_{xx} . In Fig. 9, we plot R_{xx} and R_{xy} for device H₃ as a function of back-gate voltage V_{bg} and magnetic-field strength B .

From the R_{xy} data, we calculate the inverse Hall coefficient $1/R_H$ as shown in Fig. 10(a). The strong asymmetry in R_H on

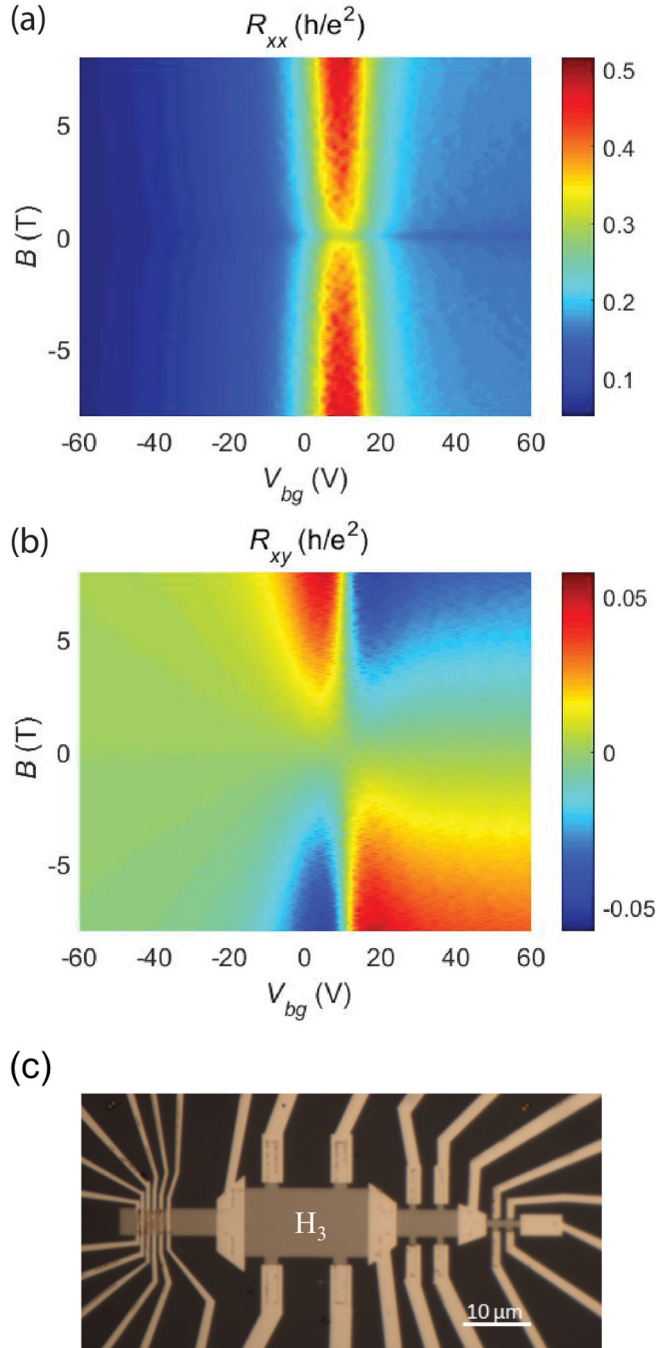


FIG. 9. (a) Longitudinal resistance R_{xx} and (b) transverse Hall resistance R_{xy} for Hall bar device H_3 . (c) An optical image of device H_3 , which comprises the central region (labeled) of the fabricated sample. The other regions in the image are not used for this paper.

different sides of the CNP reflects an asymmetry in the band structure of the TI films. The sharp peaks in $1/R_H$ near the CNP reflect a vanishing of the Hall resistance due to equal concentrations of electron and hole puddles, and they are not an indication of any singular behavior in the carrier concentration. The minimum value of $|1/R_H| \sim 3 \times 10^{12} \text{ cm}^{-2}$ suggests a typical carrier density of electron and hole puddles. Similar results for R_H were seen in Ref. [42].

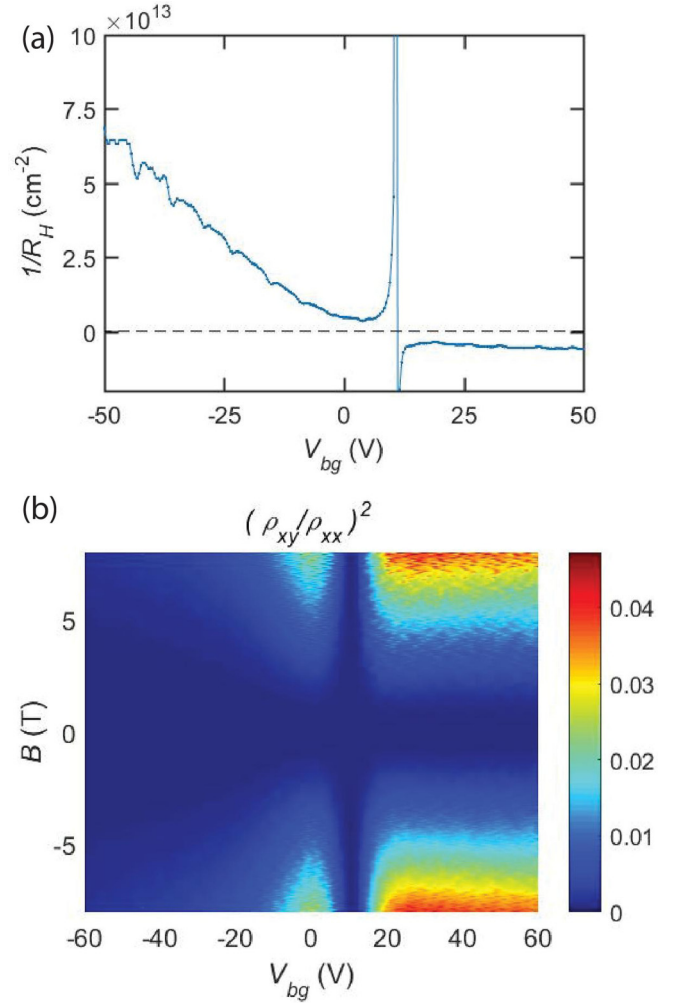


FIG. 10. (a) Inverse Hall coefficient as a function of back-gate voltage. (b) Ratio of $(\rho_{xy}/\rho_{xx})^2$ plotted as a function of magnetic-field and back-gate voltages. Data correspond to device H_3 , which has an aspect ratio of $L/w \approx 1$.

In the presence of a perpendicular magnetic field, the conductivity is given, in general, by

$$\begin{aligned} \sigma_{xx} &= \frac{\rho_{xx}}{(\rho_{xx}^2 + \rho_{xy}^2)} \\ &= \frac{1}{\rho_{xx}(1 + \rho_{xy}^2/\rho_{xx}^2)}. \end{aligned} \quad (\text{A1})$$

Figure 10(b) shows that for all relevant magnetic-field and back-gate voltages, the quantity $(\rho_{xy}/\rho_{xx})^2 \ll 1$. Hence, the global conductivity can be well approximated by $\sigma_{xx} \approx 1/\rho_{xx}$.

APPENDIX B: DUAL-GATING

In some of our samples, both a back gate and a top gate were fabricated, allowing the chemical potential to be modulated by two independent gate voltages. In Fig. 11, we present the low-temperature longitudinal resistance R_{xx} for sample H_4 as a function of the top- and back-gate voltages V_{tg} and V_{bg} , respectively. For this sample, the longitudinal resistance

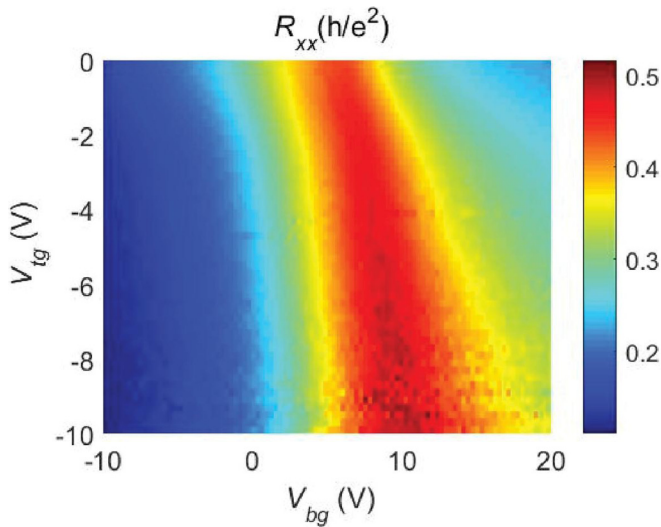


FIG. 11. Dependence of the longitudinal resistance R_{xx} on top- and back-gate voltages for device H₄.

exhibits a maximum of $\approx 0.5h/e^2$ at the CNP, and there is no sign of an insulating state with large resistance. The somewhat weaker variation of the resistance with V_{tg} as compared to its variation with V_{bg} is consistent with the top-gate capacitance being smaller than the back-gate capacitance.

APPENDIX C: SUPERCONDUCTING PROXIMITY EFFECT

Coupling superconductivity to TI surface states is predicted to create a $p_x + ip_y$ superconductor with Majorana bound states [43,43–45]. Such Majorana states may enable topologically protected qubits for quantum computation [46], and consequently, there has been an intensive search for Majorana modes in exfoliated 3D TIs [47–49]. Achieving Josephson coupling is an important step towards engineering topological superconductivity.

We investigated superconducting Josephson coupling mediated by the TI thin film as depicted schematically in Fig. 12(a). An important consideration for achieving Josephson coupling is a transparent superconducting contact with minimum contact resistance. To make transparent contacts, we etched the tellurium capping layer covering our topological insulator film (Bi, Sb)₂Te₃ and *in situ* evaporated Ti (5 nm)/Nb (2.5 nm)/NbN (50 nm) without breaking vacuum in the evaporation chamber. The device dimensions were $6 \times 0.1 \mu\text{m}^2$, as shown in Fig. 12(b).

The interference pattern of the critical current $I_c(B)$ of the Josephson junction under perpendicular magnetic-field B gives valuable information about the Josephson current density $J_c(x)$ along the junction width. In the case of a spatially uniform Josephson current density, the interference pattern corresponds to a single-slit Fraunhofer pattern where the lobes of I_c decays with $1/B$. On the other hand, for TIs in which conduction occurs dominantly at the edges of the system, the interference pattern is expected to resemble the double-slit-like diffraction pattern of a dc SQUID with nondecaying lobes. In this case the critical current $I_c(B)$ is

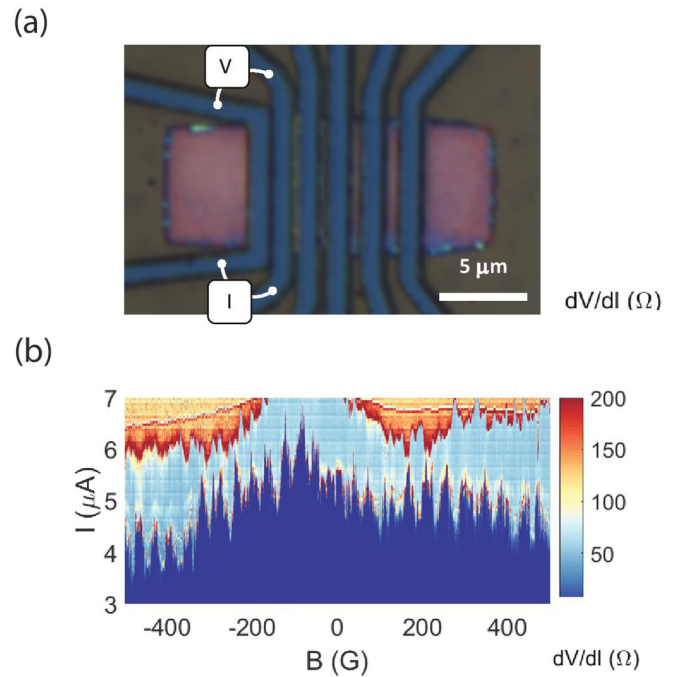


FIG. 12. (a) Optical image and (b) Fraunhofer pattern of device JJ1.

given by

$$I_c(B) = I_c \left| \cos \left(\frac{\pi AB}{\phi_0} \right) \right|, \quad (\text{C1})$$

where ϕ_0 is the magnetic flux quantum and A is the area of the junction. Similar analyses of the interference pattern of Josephson junctions has shown edge dominant conduction in a HgTe/HgCdTe 2D topological insulator [50] and Bi_{1.5}Sb_{0.5}Te_{1.7}Se_{1.3} 3D TIs [51]. In our devices, the normal junction resistance $R_N \approx 60 \Omega$ and the maximum Josephson current $I_c \approx 7 \mu\text{A}$ at the temperature of 50 mK give $I_c R_N \approx 420 \mu\text{eV}$, which corresponds to about $\Delta_{sc}/6e$, where Δ_{sc} is the superconducting gap. The Josephson junction displays an interference pattern as shown in Fig. 12(b), that cannot be explained by a uniform Josephson current distribution. The extracted period of the quasiperiodic oscillation of I_c is about 35 G, which matches well with the expected value of $\phi_0/A = 34$ G. Imperfect constructive and destructive interferences visible in the pattern are indicative of the effect of random disorder in the junction. Proximity-induced Josephson coupling and the similar interference pattern were also observed by us in Josephson junctions made of Ti (5 nm)/Al (50 nm).

APPENDIX D: NUMERIC SIMULATIONS OF CURRENT FLOW

In the main text, we presented results for the magnetoresistance based on a model where the local conductivity tensor $\hat{\sigma}(\mathbf{r})$ varies with the position \mathbf{r} due to spatial variations in the electron/hole concentration. Here we present more details about our numeric simulations of the resistivity.

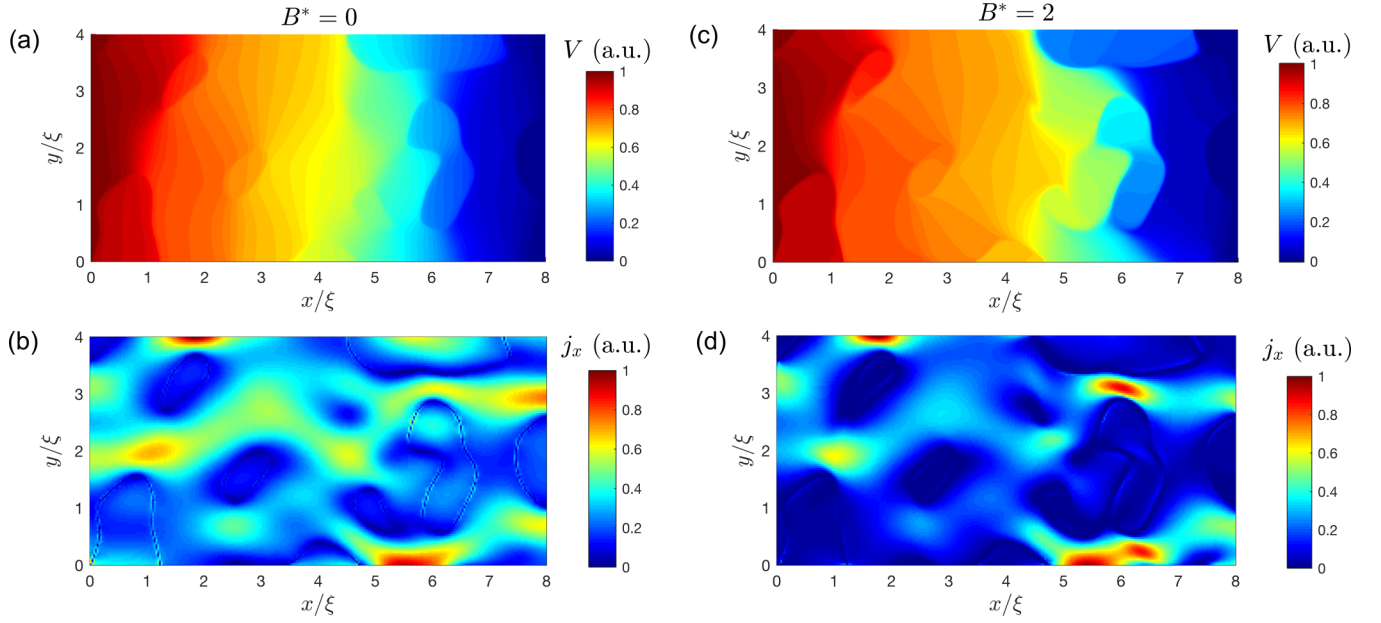


FIG. 13. Example numeric solutions for the electrochemical potential V and the current j_x in the x direction for a given realization of the random potential $P(x, y)$. (a) and (b) correspond to zero magnetic fields, and (c) and (d) correspond to the same random potential with a field of $B^* = 2$. (b) and (d) have the same color scale. All images correspond to zero chemical potential $\mu = 0$.

Within the Drude model, the conductivity tensor has the form

$$\hat{\sigma}(\mathbf{r}) = \begin{pmatrix} \sigma_{xx}(\mathbf{r}) & -\sigma_{xy}(\mathbf{r}) \\ \sigma_{xy}(\mathbf{r}) & \sigma_{xx}(\mathbf{r}) \end{pmatrix}, \quad (\text{D1})$$

where the values of $\sigma_{xx}(\mathbf{r})$ and $\sigma_{xy}(\mathbf{r})$ are related to the value of the local electrostatic potential by

$$\begin{aligned} \sigma_{xx}(\mathbf{r}) &= \frac{e^2}{h} k_F(\mathbf{r}) \ell \frac{1}{1 + [\omega_c(\mathbf{r})\tau]^2}, \\ \sigma_{xy}(\mathbf{r}) &= \frac{e^2}{h} k_F(\mathbf{r}) \ell \frac{\omega_c(\mathbf{r})\tau}{1 + [\omega_c(\mathbf{r})\tau]^2}, \end{aligned} \quad (\text{D2})$$

where $k_F(\mathbf{r})$ is the local value of the Fermi momentum, $\omega_c(\mathbf{r})$ is the local value of the cyclotron frequency, τ is the transport scattering time, and $\ell = v\tau$ is the mean free path. In principle, both ℓ and τ may have a dependency on the local Fermi energy and therefore on position. However, for simplicity in our numeric simulations, we take ℓ and τ to be constants with no spatial variation. The local Fermi momentum $k_F(\mathbf{r})$ is related to the disorder potential $\phi(\mathbf{r})$ by the Thomas-Fermi equation, Eq. (7) of the main text.

In order to address the problem computationally, we define the following dimensionless units. First, we define a normalized electrochemical potential:

$$P(\mathbf{r}) = \frac{e\phi(\mathbf{r}) + \mu}{\sqrt{\langle (e\phi)^2 \rangle_{\mathbf{r}}}}, \quad (\text{D3})$$

so that $P(\mathbf{r})$ has a standard deviation of unity. Here, μ is the chemical potential and $\sqrt{\langle (e\phi)^2 \rangle_{\mathbf{r}}} \equiv \Gamma$ is the root-mean-square value of the disorder potential. The local value of the

Fermi momentum is then given by

$$k_F(\mathbf{r}) = \bar{k}_F |P(\mathbf{r})|, \quad (\text{D4})$$

where $\bar{k}_F = \Gamma/(\hbar v)$ represents the root-mean-square value of the Fermi momentum at zero chemical potential.

We also define a dimensionless magnetic-field strength,

$$B^* \equiv \frac{eB\ell^2}{\hbar} = \left(\frac{\ell}{\ell_B} \right)^2, \quad (\text{D5})$$

where $\ell_B = \sqrt{\hbar/(eB)}$ is the magnetic length. With these definitions, $\omega_c\tau = (\bar{k}_F\ell)^{-1} B^*/P(\mathbf{r})$, and we can rewrite the elements of the conductivity tensor in dimensionless form as

$$\begin{aligned} \frac{\sigma_{xx}(\mathbf{r})}{e^2/h} &= \frac{\bar{k}_F\ell |P(\mathbf{r})|}{1 + \left(\frac{1}{\bar{k}_F\ell} \right)^2 \left[\frac{B^*}{P(\mathbf{r})} \right]^2}, \\ \frac{\sigma_{xy}(\mathbf{r})}{e^2/h} &= \frac{B^* \text{sgn}\{P(\mathbf{r})\}}{1 + \left(\frac{1}{\bar{k}_F\ell} \right)^2 \left[\frac{B^*}{P(\mathbf{r})} \right]^2}. \end{aligned} \quad (\text{D6})$$

Written in this form, the system is characterized by three dimensionless parameters: B^* , μ/Γ , and $\bar{k}_F\ell$. For a given choice of these parameters and for a given realization of the random potential $P(\mathbf{r})$, one can solve for the current density $\mathbf{j}(\mathbf{r})$ through the system by solving the continuity equation,

$$\nabla \cdot \mathbf{j} = 0, \quad (\text{D7})$$

where $\mathbf{j} = -\hat{\sigma} \nabla V(\mathbf{r})$ and $V(\mathbf{r})$ is the local deviation of the electrochemical potential away from equilibrium. Below we present results based on a finite-element solution to Eq. (D7). For definiteness, we choose our simulated system to be a Hall bar with length $L = 8\xi$ and width $w = 4\xi$, where ξ is the correlation length of the potential (equivalent to r_s in the main text). Applying a unit voltage across the long end of the bar

gives the boundary conditions $V(x=0) = 1$, $V(x=L) = 0$, and $j_y(y=0) = j_y(y=w) = 0$. The finite-element mesh size was $\xi/20$.

The random potential was taken to be a Fourier series with random coefficients whose magnitude decreases at high wave vectors. Specifically, we write

$$P(x, y) = \text{Re} \left\{ \sum_{m,n=-\infty}^{\infty} c_{m,n} e^{i(k_m x + k_n y)} \right\} + \frac{\mu}{\Gamma}, \quad (\text{D8})$$

where $c_{m,n}$ are random coefficients and

$$k_m = \frac{\pi m}{L}, \quad k_n = \frac{\pi n}{w}. \quad (\text{D9})$$

The coefficients $c_{m,n}$ are chosen to have a random phase in the complex plane and a random magnitude bounded by

$$|c_{m,n}|^2 \leq e^{-(k_m^2 + k_n^2) \xi^2 / 2}. \quad (\text{D10})$$

The normalization of the potential is such that $c_{0,0} = 0$ and $\frac{1}{2} \sum_{m,n} |c_{m,n}|^2 = 1$.

Figure 13 shows a typical numerical solution for the potential $V(x, y)$ and the current j_x in the x direction at $\mu = 0$. Figures 13(a) and 13(b) show the potential and current at zero-field $B^* = 0$, whereas Figs. 13(c) and 13(d) show the same system at large-field $B^* = 2$. One can see from these images the strong effect of pinch points in the random potential where the current is concentrated at narrow constrictions between puddles. This focusing of the current becomes more exaggerated at large magnetic fields, and correspondingly, the electrochemical potential $V(\mathbf{r})$ drops abruptly at pinch points and becomes relatively constant far from the boundaries between n - and p -type regions.

For a given realization of the random potential, the longitudinal resistivity can be defined from the simulation as $\rho_{xx} = \Delta V / (L \langle j_x \rangle)$, where $\langle j_x \rangle$ is the area-averaged current density in the z direction and $\Delta V \equiv 1$ is the voltage drop across the system. One can estimate the dependence of ρ_{xx} on magnetic-field B^* by averaging the simulated resistivity ρ_{xx} over many realizations of the random potential for a given value of B^* . Our numerical results, including those shown in Fig. 8 of the main text, are averaged over 100 such realizations. One can also define the Hall resistivity ρ_{xy} by numerically extracting the transverse voltage V_H across the Hall bar at the midpoint $x = 4\xi$ for a given realization. The Hall resistivity is defined by $\rho_{xy} = V_H / (w \langle j_x \rangle)$.

In Fig. 14, we show the values of ρ_{xx} and ρ_{xy} as produced by our simulation for a range of magnetic-fields B^* and μ/Γ . As in the experimental data (see Fig. 9), ρ_{xy} is much smaller than ρ_{xx} throughout the range of interest.

In order to fit the experimental data at $\mu = 0$ to the numerical simulation, we calculate numerically the resistivity

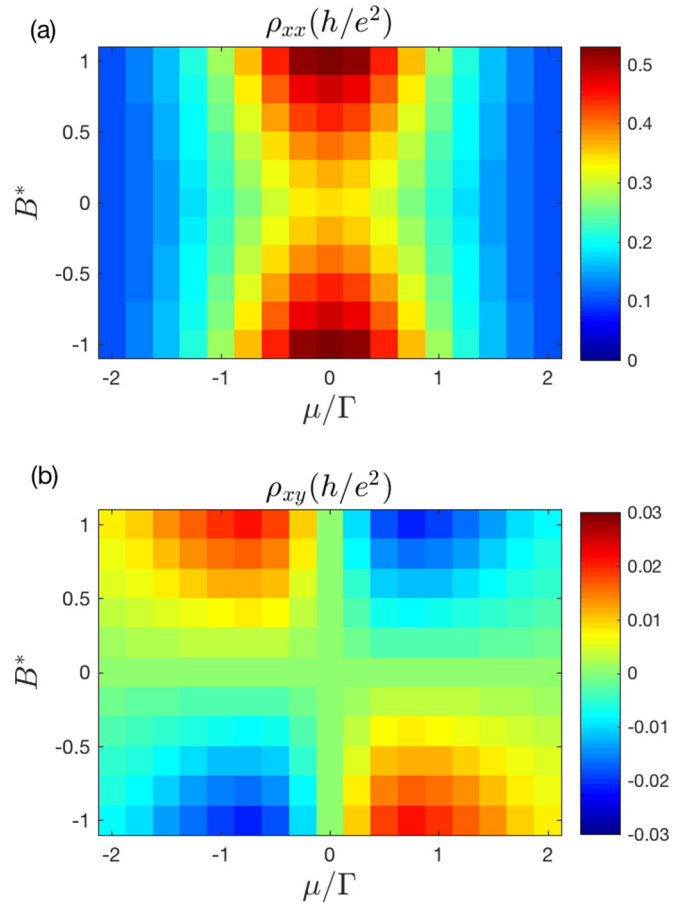


FIG. 14. Simulated values of the (a) longitudinal and (b) Hall resistivities as a function of magnetic field and chemical potential. The vertical axis corresponds to the dimensionless magnetic-field B^* , whereas the horizontal axis corresponds to the chemical potential μ in units of the root-mean-square disorder potential Γ . In this example, $\bar{k}_F \ell = 6$ everywhere. Compare to Fig. 9, and note that the scale of ρ_{xy} is much smaller than ρ_{xx} .

$\rho_{xx}/(h/e^2)$ as a function of B^* using discrete points $B^* = 0, 0.1, 0.2, \dots, 2$ for $\ell = 5-7$. Linear interpolation allows us to estimate the value of ρ_{xx} for generic values of $\bar{k}_F \ell$ between 5 and 7 and B^* between 0 and 2. The resulting curves can be translated into real units by inserting the corresponding values of \bar{k}_F and ℓ , which allows us to fit the data shown in Fig. 7(b) of the main text. The result of this fitting is shown in Fig. 8(b) of the main text and corresponds to $\bar{k}_F \ell = 6.5$ and $\bar{k}_F = 0.88 \text{ nm}^{-1}$. This value of \bar{k}_F implies a typical electron/hole density $2\pi \bar{k}_F^2 = 1.2 \times 10^{13} \text{ cm}^{-2}$, which is consistent in order of magnitude with both our theoretical estimates and our measurements of the Hall constant.

We extracted the dependence of the linear magnetoresistance slope $d[\rho_{xx}/(h/e^2)]/dB^*$ on the chemical potential by numerically evaluating the curve $\rho_{xx}(B^*)$ for different values of μ/Γ and then fitting each curve to a line over the range $0.2 < B^* < 1$.

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